Vishay Siliconix

RoHS*

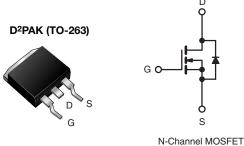
COMPLIANT HALOGEN

FREE

Power MOSFET

S

| PRODUCT SUMMARY | | | | | |
|----------------------------|-----------------|-----|--|--|--|
| V _{DS} (V) | 400 | | | | |
| R _{DS(on)} (Ω) | $V_{GS} = 10 V$ | 1.0 | | | |
| Q _g (Max.) (nC) | 38 | | | | |
| Q _{gs} (nC) | 5.7 | | | | |
| Q _{gd} (nC) | 22 | | | | |
| Configuration | Single | | | | |



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

| ORDERING INFORMATION | | | | | | | |
|---------------------------------|-----------------------------|------------------------------|------------------------------|--|--|--|--|
| Package | D ² PAK (TO-263) | D ² PAK (TO-263) | D ² PAK (TO-263) | | | | |
| Lead (Pb)-free and Halogen-free | SiHF730S-GE3 | SiHF730STRL-GE3 ^a | SiHF730STRR-GE3 ^a | | | | |
| | IRF730SPbF | IRF730STRLPbF ^a | - | | | | |
| Lead (Pb)-free | SiHF730S-E3 | SiHF730STL-E3ª | - | | | | |
| | SiHF730S-E3 | SiHF730STL-E3 ^a | - | | | | |
| Note | | | · | | | | |

a. See device orientation.

| PARAMETER | SYMBOL | LIMIT | UNIT | | | |
|--|-------------------------|-------------------------|-----------------------------------|---------------|------|--|
| Drain-Source Voltage | V _{DS} | 400 | V | | | |
| Gate-Source Voltage | V _{GS} | ± 20 | 1 | | | |
| Continuous Drain Current | V _{GS} at 10 V | T _C = 25 °C | I- | 5.5 | А | |
| Continuous Drain Gurrent | VGS at 10 V | T _C = 100 °C | ID | 3.5 | | |
| Pulsed Drain Current ^a | | | I _{DM} | 22 | | |
| Linear Derating Factor | | | | 0.59 | W/°C | |
| Linear Derating Factor (PCB Mount) ^e | | 0.025 | VV/ U | | | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 290 | mJ | |
| Avalanche Current ^a | | | I _{AR} | 5.5 | A | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 7.4 | mJ | |
| Maximum Power Dissipation | р | 74 | W | | | |
| Maximum Power Dissipation (PCB Mount) ^e | P _D – | 3.1 | | | | |
| Peak Diode Recovery dV/dt ^c | dV/dt | 4.0 | V/ns | | | |
| Operating Junction and Storage Temperature Ra | nge | | T _J , T _{stg} | - 55 to + 150 | °C | |
| Soldering Recommendations (Peak Temperature) | | 300 ^d | | | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 16 mH, $R_g = 25 \Omega$, $I_{AS} = 5.5 \text{ A}$ (see fig. 12). c. $I_{SD} \le 5.5 \text{ A}$, dI/dt $\le 90 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$. d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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| THERMAL RESISTANCE RATINGS | | | | | | | |
|---|-------------------|------|------|------|--|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | | | | |
| Maximum Junction-to-Ambient (PCB Mount) ^a | R _{thJA} | - | 40 | °C/W | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 1.7 | | | | |

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

| PARAMETER SYMBOL TES | | | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|--|------------------------------------|--|------------|-----------|----------|------|
| Static | | | | | | | • |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} | = 0, I _D = 250 μA | 400 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 0.54 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | | | 4.0 | V |
| Gate-Source Leakage | I _{GSS} | , | - | - | ± 100 | nA | |
| Zana Oata Maltana Duain Orimont | | V _{DS} = | $V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | - | 25 | Ι. |
| Zero Gate Voltage Drain Current | ate Voltage Drain Current I_{DSS} $V_{DS} = 320 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ | | ′, V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 3.3 A ^b | - | - | 1.0 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} = | 50 V, I _D = 3.3 A ^b | 2.9 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 700 | - | |
| Output Capacitance | C _{oss} | | $V_{DS} = 25 V$, | - | 170 | - | pF |
| Reverse Transfer Capacitance | C _{rss} | f = 1. | 0 MHz, see fig. 5 | - | 64 | - | |
| Total Gate Charge | Qg | | | - | - | 38 | nC |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 V$ | $I_D = 3.5 \text{ A}, V_{DS} = 320 \text{ V},$ see fig. 6 and 13 ^b | - | - | 5.7 | |
| Gate-Drain Charge | Q _{gd} | _ | | - | - | 22 | |
| Turn-On Delay Time | t _{d(on)} | | | - | 10 | - | - ns |
| Rise Time | t _r | V _{DD} = | 200 V, I _D = 3.5 A, | - | 15 | - | |
| Turn-Off Delay Time | t _{d(off)} | $R_g = 12 \Omega$, | $R_D = 57 \Omega$, see fig. 10^{b} | - | 38 | - | |
| Fall Time | t _f | | | - | 14 | - | |
| Internal Drain Inductance | L _D | 6 mm (0.25") f | Between lead, 6 mm (0.25") from | | | - | nH |
| Internal Source Inductance | L _S | package and die contact | die contact | | 7.5 | - | |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | showing the | MOSFET symbol showing the integral reverse p - n junction diode | | - | 5.5 | А |
| Pulsed Diode Forward Current ^a | I _{SM} | 0 | | | - | 22 | ~ |
| Body Diode Voltage | V_{SD} | T _J = 25 °C | , $I_{\rm S} = 5.5$ A, $V_{\rm GS} = 0$ V ^b | - | - | 1.6 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T 25 °C I | = 3.5 A, dl/dt = 100 A/µs ^b | - | 270 | 530 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | $I_{\rm J} = 25$ C, I _F | $= 0.0 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{S}^{\circ}$ | - | 1.8 | 2.2 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic tu | rn-on time is negligible (turn | -on is dor | ninated b | v Ls and | Ln) |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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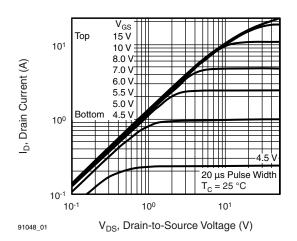


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

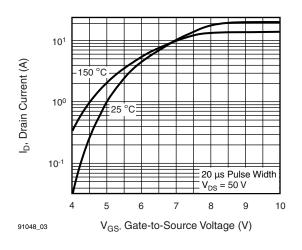


Fig. 3 - Typical Transfer Characteristics

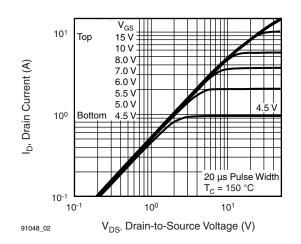


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

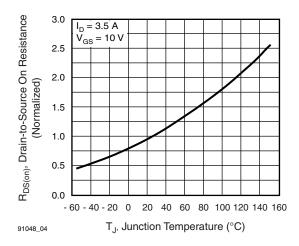


Fig. 4 - Normalized On-Resistance vs. Temperature

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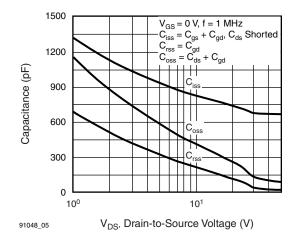


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

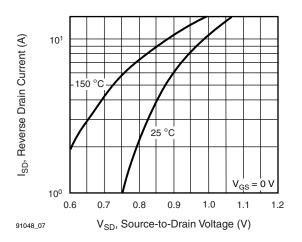


Fig. 7 - Typical Source-Drain Diode Forward Voltage

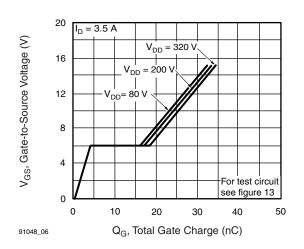


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

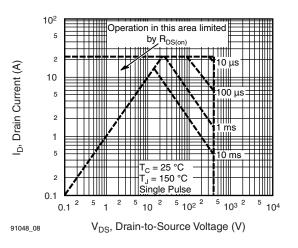


Fig. 8 - Maximum Safe Operating Area

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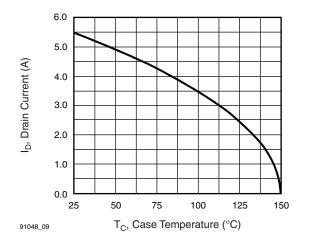


Fig. 9 - Maximum Drain Current vs. Case Temperature

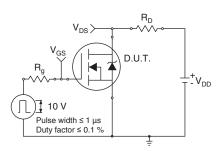


Fig. 10a - Switching Time Test Circuit

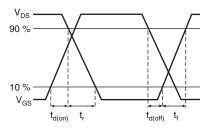


Fig. 10b - Switching Time Waveforms

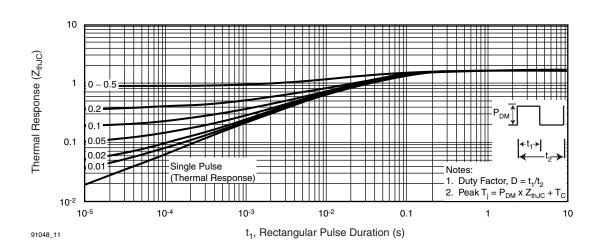


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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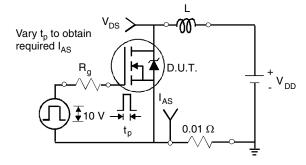


Fig. 12a - Unclamped Inductive Test Circuit

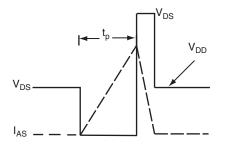


Fig. 12b - Unclamped Inductive Waveforms

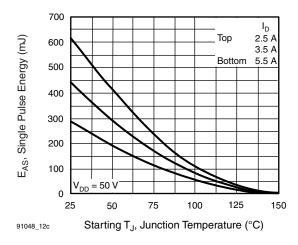
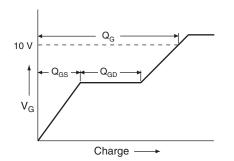


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





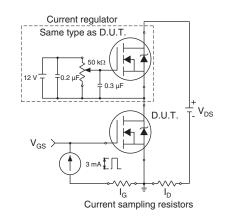


Fig. 13b - Gate Charge Test Circuit

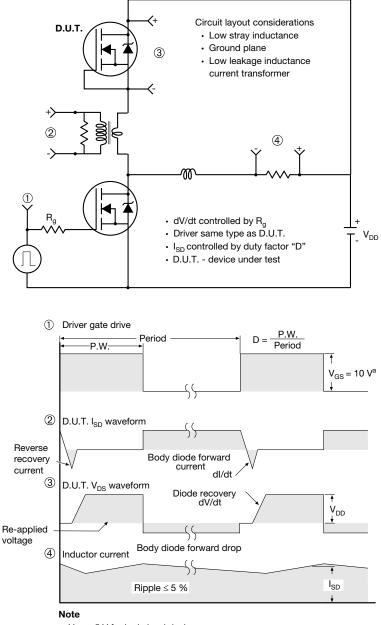
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91048</u>.

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

| | 2 | - | Y 2 x b2 2 x b ⊕ 0.010 @ A(| ■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c) | $\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$ | a - 1 | | Ū. | 1 <u>4</u> | |
|--------------------------------|--|--|--|---|---|-------------------------------|---|---|--|--|
| | MILLIN | IETERS | INCHES | | | | MILLIMETERS | | INCHES | |
| DIM. | MIN. | MAX. | MIN. | MAX. | | DIM. | MIN. | MAX. | MIN. | MAX. |
| А | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | - | 0.270 | - |
| | | | | 0.010 | | F | | 10.07 | 0.000 | 0.420 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 | | E | 9.65 | 10.67 | 0.380 | 0.120 |
| A1 b | 0.00 0.51 | 0.25 0.99 | 0.000 | 0.010 | | E1 | 9.65 6.22 | - 10.67 | 0.380 | - |
| | | | | | | | 6.22 | - 10.67 - BSC | 0.245 | - BSC |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 6.22 | - | 0.245 | - |
| b b1 | 0.51 0.51 | 0.99 0.89 | 0.020 0.020 | 0.039 0.035 | | E1 e | 6.22 2.54 | - BSC | 0.245 | -) BSC |
| b b1 b2 | 0.51 0.51 1.14 | 0.99 0.89 1.78 | 0.020 0.020 0.045 | 0.039 0.035 0.070 | | E1 e H | 6.22 2.54 14.61 | - BSC 15.88 | 0.245 0.100 0.575 | -) BSC 0.625 |
| b b1 b2 b3 | 0.51 0.51 1.14 1.14 | 0.99 0.89 1.78 1.73 | 0.020 0.020 0.045 0.045 | 0.039 0.035 0.070 0.068 | | E1 e H L | 6.22 2.54 14.61 1.78 | - BSC 15.88 2.79 | 0.245 0.100 0.575 0.070 | - 0 BSC 0.625 0.110 |
| b b1 b2 b3 c | 0.51 0.51 1.14 1.14 0.38 | 0.99 0.89 1.78 1.73 0.74 | 0.020 0.020 0.045 0.045 0.015 | 0.039 0.035 0.070 0.068 0.029 | | E1 e H L L1 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 |
| b b1 b2 b3 c c1 | 0.51 0.51 1.14 1.14 0.38 0.38 | 0.99 0.89 1.78 1.73 0.74 0.58 | 0.020 0.020 0.045 0.045 0.015 0.015 | 0.039 0.035 0.070 0.068 0.029 0.023 | | E1 e H L L1 L2 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 1.78 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 0.070 |

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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